

Intel[®] Solid-State Drive DC P3700 Series

- Capacities: 400GB, 800GB, 1.6TB, 2TB
- Components
 - Intel[®] 20nm MLC NAND Flash Memory
- Form Factors
 - 2.5-inch Form Factor
 - 15mm Z-height
 - 8639-compatible connector
 - AIC Form Factor
 - Half-height, Half-length
 - Single slot x4 connector
- PCIe* Gen3 X4
- Performance^{1,2}
 - Seq R/W: Up to 2800/2000MB/s³
 - IOPS Rnd 4KB⁴ 70/30 R/W: Up to 265K
 - IOPS Rnd $4KB^4$ R/W: Up to 460/175K
 - Seq Latency (typ) R/W: 20/20µs
- Operating System Support:
 - Windows* Server 2012 R2, 2012, 2008 R2 x64
 - Windows* 7, Windows* 8, Windows* 8.1, 10 (32/64bit)
 - RHEL* 6.5, 6.6, 6.7,7.0, 7.1
 - SLES11 SP3*, SP4, SLES12
 - Citrix* XenServer* 6.5
 - VMWare* ESXi 5.5
 - CentOS* 6.5
 - UEFI 2.3.1*
- Reliability
 - Uncorrectable Bit Error Rate (UBER):
 1 sector per 10¹⁷ bits read
 - Mean Time Before Failure (MTBF):
 2 million hours
 - T10 DIF protection
 - Variable Sector Size: 512, 520, 528, 4096, 4104, 4160, 4224 Bytes
- Compliance
 - NVM Express* 1.0
 - PCI Express* Base Specification Rev 3.0
 - Enterprise SSD Form Factor Version 1.0a
 - PCI Express Card Electro-Mechanical (CEM) Specification Rev 2.0
- Certifications and Declarations
 - UL*, CE*, C-Tick*, BSMI*, KCC*, Microsoft* WHQL*, VCCI*

- **Product Specification**
- Power
 - 2.5-inch: 3.3V and 12V Supply Rail
 - AIC: 3.3V and 12V Supply Rail
 - Enhanced power-loss data protection
 Active/Idle (TYP): Up to 25W/4W (TYP)
- Active/Idle (1)
 Endurance Rating
 - Line to 62 OF DBW (Detabutes Write
 - Up to 62.05 PBW (Petabytes Written)⁵
 - Up to 17 Drive Writes/day (JESD219 workload)
- Temperature Specification
 - Operating:
 - AIC: 0 to 55° C ambient with specified airflow
 - 2.5-inch: 0 to 35° C ambient, 0 to 70° C case with specified airflow
 - Non-Operating⁶: -55 to 95° C
 - Temperature monitoring (In-band and by way of SMBUS)
 - Thermal throttling when approaching maximum operating temperature
- Airflow
 - AIC (55° C airflow towards IO bracket⁷)
 - 400GB: 200 LFM
 - 800GB, 1.6TB, 2.0TB: 300 LFM
 - 2.5-inch (Airflow towards the connector)
 - 400GB: 250/300 LFM (25/35° C)
 - 800GB: 350/500 LFM (25/35° C)
 - 1.6TB, 2TB: 450/600 LFM (25/35° C)
- Weight
 - AIC: 400/800GB up to 185gm
 - 1.6TB, 2TB up to 195gm
 - 2.5-inch: 400/800GB up to 115gm
 - 1.6TB, 2TB up to 125gm
- Shock
 - 2.5-inch: 1,000 G/0.5msec
 - AIC: 50 G Trapezoidal, 170 in/s
- Vibration
 - Operating: 2.17 G_{RMS} (5-700Hz)
 - Non-Operating: 3.13 G_{RMS} (5-800Hz)
- Altitude (Simulated)
 - Operating: -1,000 to 10,000 ft
 - Non-Operating: -1,000 to 40,000 ft
- Product Ecological Compliance
 - RoHS
- 1. Performance values vary by capacity and form factor
- 2. Performance specifications apply to both compressible and incompressible data
- 3. MB/s = 1,000,000 bytes/second
- 4. 4KB = 4,096 bytes; 8KB = 8,192 bytes
- 5. 1PB = 10¹⁵ Bytes
- 6. Please contact your Intel representative for details on the non-operating temperature range
- 7. Airflow out of server through PCIe Card Slot



Ordering Information

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Tests document performance of components on a particular test, in specific systems. Differences in hardware, software, or configuration will affect actual performance. Consult other sources of information to evaluate performance as you consider your purchase.

All documented endurance test results are obtained in compliance with JESD218 Standards; refer to individual sub-sections within this document for specific methodologies. See <u>www.jedec.org</u> for detailed definitions of JESD218 Standards.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

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Revision History

Revision Number	Description	Revision Date
001	Initial release	June 2014
002	Driver and temperature updatesUpdated performance information	July 2014
003	Updated power number for 400GB Update driver/OS support list	September 2014
004	Endurance rating corrected	September 2014
005	 Added clarification in SMART critical warning Corrected error is QoS percentile Modified power governor setting target for 01 and 02 	October 2014
006	 Updated Endurance Specifications Updated Log Identifier 0xCA and Identify Data Structure SMBUS footnote Added RHEL 6.6 Operating System Support 	January 2015
007	 Updated Quality of Service values Modified C7 (CRC Error Count) Description Modified Table 16 footnote Updated Power on to Ready specification 	March 2015
008	Updated IDENTIFY Data Structure	March 2015
009	 Updated OS support list Added additional log page supports (05h,C1h,C2h) Updated CAh log page with NAND Bytes and Host Bytes Written attributes Updated SMBUS management features Clarified slew rate requirement 	May 2015



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1 **Overview**

This document describes the specifications and capabilities of the Intel® Solid-State Drive (SSD) Data Center P3700 Series.

P3700 Series is a PCIe Gen3 SSD architected with the new high performance controller interface – NVMe (Non-Volatile Memory express) delivering leading performance, low latency and Quality of Service. Matching the performance with world-class reliability and endurance, P3700 Series offers a range of capacity – 400GB, 800GB, 1.6TB and 2TB in both Add-In card and 2.5-inch form factor.

With PCIe Gen3 support and NVMe queuing interface, the P3700 Series delivers excellent sequential read performance of up to 2.8GB/s and sequential write speeds of up to 2.0GB/s. P3700 Series delivers very high random read IOPS of 460K and random write IOPS of 175K for 4KB operations. Taking advantage of the direct path from the storage to the CPU by means of NVMe, P3700 Series exhibits low latency of less than 20 µs for sequential access to the SSD.

P3700 Series also includes High Endurance Technology (HET), which combines NAND silicon enhancements and SSD NAND management techniques to extend SSD write endurance up to 17 drive writes per day for 5 years.

The 2.5-inch P3700 Series takes advantage of the 8639 connector and provides hot-pluggable removal and insertion providing in-service replacement options.

P3700 Series includes these key features:

- Consistently High IOPS and throughput
- Sustained low latency
- High Endurance Technology (HET)
- Variable Sector Size and End-to-End data-path protection
- Enhanced power-loss data protection
- Power loss protection capacitor self-test
- Out of band management
- Thermal throttling and monitoring



1.1 References

Date	Title	Location
Jan 2013	Enterprise SSD Form Factor Version 1.0a	http://www.ssdformfactor.org
Feb 2012	NVMe Revision 1.0c	http://www.nvmexpress.org
Nov 2010	PCIe Base Specification Revision 3.0	http://pcisig.com
July 2012	Solid-State Drive (SSD) Requirements and Endurance Test Method (JESD219)	http://www.jedec.org/standards- documents/results/jesd219
Sept 2010	Solid-State Drive (SSD) Requirements and Endurance Test Method (JESD218)	http://www.jedec.org/standards- documents/docs/jesd218/
Dec 2008	vcci	http://www.vcci.jp/vcci_e/
June 2009	RoHS	http://qdms.intel.com/ Click Search MDDS Database and search for material description datasheet
1995 1996 1995 1995 1997 1994	 International Electrotechnical Commission EN 61000 4-2 (Electrostatic discharge immunity test) 4-3 (Radiated, radio-frequency, electromagnetic field immunity test) 4-4 (Electrical fast transient/burst immunity test) 4-5 (Surge immunity test) 4-6 (Immunity to conducted disturbances, induced by radio-frequency fields) 4-11 (Voltage Variations, voltage dips, short interruptions and voltage variations immunity tests) 	http://www.iec.ch/
1995	ENV 50204 (Radiated electromagnetic field from digital radio telephones)	http://www.dbicorporation.com/ radimmun.htm/



1.2 Terms and Acronyms

Table 2: Glossary of Terms and Acronyms

Term	Definition				
ATA	Advanced Technology Attachment				
CRC	Cyclic Redundancy Check				
DAS	Device Activity Signal				
DMA	Direct Memory Access				
ECC	Error Correction Code				
EEPROM	Electrically Erasable Programmable Read Only Memory				
EXT	Extended				
FPDMA	First Party Direct Memory Access				
GB	Gigabyte Note: The total usable capacity of the SSD may be less than the total physical capacity because a small portion of the capacity is used for NAND flash management and maintenance purposes.				
Gb	Gigabit				
HDD	Hard Disk Drive				
HET	High Endurance Technology				
КВ	Kilobyte				
I/O	Input/Output				
IOPS	Input/Output Operations Per Second				
ISO	International Standards Organization				
LBA	Logical Block Address				
MB	Megabyte (1,000,000 bytes)				
MLC	Multi-level Cell				
MTBF	Mean Time Between Failures				
NOP	No Operation				
NVMe	Non-Volatile Memory Express				
РВ	Petabyte				
PCB	Printed Circuit Board				
RDT	Reliability Demonstration Test				
RMS	Root Mean Square				
SSD	Solid-State Drive				
ТВ	Terabyte				
ТҮР	Typical				
UBER	Uncorrectable Bit Error Rate				
VPD	Vital Product Data				



2 **Product Specifications**

2.1 Capacity

Table 3: User Addressable Sectors

Intel SSD DC P3700 Series	Unformatted Capacity (Total User Addressable Sectors in LBA Mode)
400GB	781,422,768
800GB	1,562,824,368
1.6TB	3,125,627,568
2ТВ	3,907,029,168

NOTES:

1 GB = 1,000,000,000 bytes; 1 sector = 512 bytes or 520 bytes or 528 bytes.

LBA count shown represents total user storage capacity and will remain the same throughout the life of the drive.

The total usable capacity of the SSD may be less than the total physical capacity because a small portion of the capacity is used for NAND media management and maintenance. IDEMA or JEDEC standard is used.

2.2 Performance

Table 4: Random Read/Write Input/Output Operations Per Second (IOPS)

Specification ¹	Unit	Intel SSD DC P3700 Series			
Specification		400GB	800GB	1.6TB	2TB
Random 4KB 70/30 Read/Write (up to) ²	IOPS	150,000	200,000	240,000	265,000
Random 8KB 70/30 Read/Write (up to) ³	IOPS	75,000	100,000	140,000	150,000
Random 4KB Read (up to) ²	IOPS	450,000	460,000	450,000	450,000
Random 4KB Write (up to)	IOPS	75,000	90,000	150,000	175,000
Random 8KB Read (up to) ³	IOPS	275,000	285,000	290,000	295,000
Random 8KB Write (up to)	IOPS	32,000	45,000	75,000	90,000

NOTES:

1. Performance measured using IOMeter* on Windows* Server 2012 R2 driver with Queue Depth 32 and 4 workers. Measurements are performed on a full Logical Block Address (LBA) span of the drive. Power mode set at 25W.

2. 4KB = 4,096 bytes

3. 8KB = 8,192 bytes

Product Specification 10

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Specification ¹	Unit	Intel SSD DC P3700 Series				
specification		400GB	800GB	1.6TB	2ТВ	
Random 4KB Read (up to) ²	%	90	90	90	90	
Random 4KB Write (up to)	%	90	90	90	90	
Random 8KB Read (up to) ³	%	90	90	90	90	
Random 8KB Write (up to)	%	90	90	90	90	

Table 5: Random Read/Write IOPS Consistency

NOTES:

- 1. Performance consistency measured using IOMeter* based on Random 4KB with total queue depth of 128, measured as (IOPS in the 99.9th percentile slowest 1-second interval)/(average IOPS during the test). Measurements are performed on a full Logical Block Address (LBA) span of the drive once the workload has reached steady state but including all background activities required for normal operation and data reliability
- 2. 4KB = 4,096 bytes
- 3. 8KB = 8,192 bytes

Table 6: Sequential Read and Write Bandwidth

Specification	Unit	Intel SSD DC P3700 Series				
Specification		400GB	800GB	1.6TB	2TB	
Sequential Read (up to) ¹	MB/s	2,700	2,800	2,800	2,800	
Sequential Write (up to) ¹	MB/s	1,080	1,900	1,900	2,000	

NOTES:

1. Performance measured using IOMeter* with 128 KB (131,072 bytes) of transfer size with Queue Depth 128. Power mode set at 25W.

Table 7: Latency

Specification	Intel SSD DC P3700 Series
Latency ¹ (TYP) Read Sequential/Random Write Sequential/Random Power On to PCIe Config Ready ² Power On to Controller Ready ³	20/115 μs 20/25 μs 2.0 sec (TYP) 10.0 sec (TYP)

NOTES:

- 1. Latency measured using 4 KB (4,096 bytes) transfer size with Queue Depth equal to 1 on a sequential workload using Windows Server 2012 R2 driver. Power mode set at 25W.
- 2. Power On To Ready time measured from de-assertion of PCIe* reset to PCIe Config Ready state.
- 3. Power On to Controller ready signifies when drive can begin receiving PCIe commands from host based on a single #PERESET. For power on from unsafe shutdown, power on to controller ready can take up to 20 seconds.



Table 8:Quality of Service

Specification	Unit	Intel SSD DC P3700 Series					
Specification	onic	QD = 1	QD = 128				
Quality of Service ^{1,2} (99%)							
Reads	ms	0.120	0.750				
Writes	ms	0.090 11					
Quality of Service ^{1,2} (99.99%)							
Reads	ms	4	5				
Writes	ms	0.500 (400GB) 0.250 (800GB, 1.6TB, 2.0TB)	25				

NOTES:

1. Device measured using IOMeter. Quality of Service measured using 4KB (4,096 bytes) transfer size on a random workload on a full Logical Block Address (LBA) span of the drive once the workload has reached steady state but including all background activities required for normal operation and data reliability.

2. Based on Random 4KB QD=1,128 workloads, measured as the time taken for 99.0 (or 99.99) percentile of commands to finish the round-trip from host to drive and back to host.

2.3 Electrical Characteristics

Table 9:Operating Voltage

Electrical Characteristics	Intel SSD DC P3700 Series
3.3V Operating Characteristics: (Add-in Card only)	3.3 V (±10%)
Operating Voltage range	66/3300 V/s
Rise Slew Rate (Min/Max)	0.66/3300 V/s
Fall Slew Rate (Min/Max) ¹	300 mV pp 10Hz – 100 KHz
Noise level	50 mV pp 100KHz – 20 MHz
Min Off time ²	3 seconds
Inrush Current (Typical Peak) ³	1.5 A
Max Average Current	3.0 A
12V Operating Characteristics:	12 V (+10%/-20%)
Operating Voltage range	240/12000 V/s
Rise Slew Rate (Min/Max)	2.4/12000 V/s
Fall Slew Rate (Min/Max) ¹	1000 mV pp 10Hz – 100 KHz
Noise level	100 mV pp 100KHz – 20 MHz
Min Off time ²	3 seconds
Inrush Current (Typical Peak) ³	1.5 A
Max Average Current	2.1 A/ 2.45 A (Add-in Card/ 2.5-inch FF)



Electrical Characteristics	Intel SSD DC P3700 Series
3.3Vaux Operating Characteristics:	
Operating Voltage range	3.3 V (±9%)
Rise Slew Rate (Min/Max)	66/3300 V/s
Fall Slew Rate (Min/Max) ¹	0.66/3300 V/s
Noise level	300 mV pp 10Hz – 100 KHz
	50 mV pp 100KHz – 20 MHz
Max Current	20mA/1mA (AIC/2.5-inch FF)

Notes:

- 1. Fall time needs to be equal or better than minimum in order to guarantee full functionality of enhanced power loss management.
- 2. The drive must be powered off for at least 3 seconds before powering on.
- 3. Measured during initial power supply application. Typically this will be seen within 2 seconds of initial power up. Inrush specified for 12V and 3.3V supply, not the 3.3Vaux.
- 4. 3.3Vaux is optional, not needed for power up or functionality. 3.3Vaux is needed for accessing VPD page by means of SMBUS for both form factors.

Table 10: Power Consumption

Specification	Unit	Intel SSD DC P3700 Series				
Specification	onic	400GB	800GB	1.6TB	2TB	
Active Write - Average ¹	w	12	18	22	25	
Active Read - Average ²	w	9	9	10	11	
Idle	W	4	4	4	4	

Notes:

- 1. The workload equates 128KB (131,072 bytes) Queue Depth equal to 128 sequential writes. Average power is measured using scope trigger over a 100 ms sample period.
- 2. The workload equates 128KB (131,072 bytes) Queue Depth equal to 128 sequential reads.



2.4 Environmental Conditions

Table 11: Temperature, Shock, Vibration

Temperature	Add-In card form factor	2.5-inch form factor	
Temperature Operating ¹ Non-operating ³	Ambient: 0 – 55° C / 0 -40° C² -55–95° C	Ambient: 0–35° C, Case: 0-70° C	
Temperature Gradient⁴ Operating Non-operating	30° C/hr (Typical) 30° C/hr (Typical)	30° C/hr (Typical) 30° C/hr (Typical)	
Humidity Operating Non-operating	5–95% 5–95%	5–95% 5–95%	
Shock and Vibration	Range		
Shock ⁵ Operating Non-operating	50 G Trapezoidal, 170 in/s 50 G Trapezoidal, 170 in/s	1,000 G (Max) at 0.5 msec 1,000 G (Max) at 0.5 msec	
Vibration ⁶ Operating Non-operating	2.17 GRMS (5-700 Hz) Max 3.13 G _{RMS} (5-800 Hz) Max	2.17 GRMS (5-700 Hz) Max 3.13 G _{RMS} (5-800 Hz) Max	

Notes:

- 1. Operating temperature implies ambient air temperature under defined airflow in Tables 12 and 13.
- 2. $0-55^{\circ}$ C is for airflow from the server towards the card and $0-40^{\circ}$ C is for airflow into the server.
- 3. Please contact your Intel representative for details on the non-operating temperature range.
- 4. Temperature gradient measured without condensation.
- 5. Shock specifications assume the SSD is mounted securely with the input vibration applied to the drive-mounting screws. Stimulus may be applied in the X, Y or Z axis. Shock specification is measured using Root Mean Squared (RMS) value.
- 6. Vibration specifications assume the SSD is mounted securely with the input vibration applied to the drive-mounting screws. Stimulus may be applied in the X, Y or Z axis. Vibration specification is measured using RMS value.

Table 12: Airflow Requirements for Intel SSD DC P3700 Series (Add-In Card)

Airflow		Ambient	Intel SSD DC P3700 Series			
Direction	Unit	Temperature	400GB	800GB	1.6TB	2ТВ
Towards the server	LFM	40° C	200	300	300	300
Out of the server	LFM	55° C	200	300	300	300

NOTE: For Add-In cards airflow can be for both the directions. Airflow specified is based on approach velocity.

LFM

Airflow		Ambient	Intel SSD DC P3700 Series				
Definition	Unit	Temperature	400GB	800GB	1.6TB	2TB	
Airflow Along	LFM	35° C	300	500	650	650	
Drive ¹	LFM	25° C	250	350	450	450	
Approach	LFM	35° C	70	120	155	155	
Approach Airflow ²		25%	60	0.5	110	110	

Table 13: Airflow Requirements for Intel SSD DC P3700 Series (2.5-inch Form Factor)

Notes:

1. It is recommended that airflow for 2.5-inch form factor should be towards the server, from the non-connector side to the connector side. Airflow is specified across the surface of the drive. Spacing between two SSDs is assumed to be 3mm.

85

110

110

2. The approach velocity of the airflow will be less than the airflow along the surface. Approach area of 1.35 ft² is assumed.

60

2.5 Product Regulatory Compliance

Intel SSD DC P3700 Series meets or exceeds the following regulatory or certification requirements.

Table 14: Product Regulatory Compliance Specifications

25° C

Title	Description	Region For Which Conformity Declared
TITLE 47-Telecommunications CHAPTER 1 – FEDERAL COMMUNMICATIONS COMMISSION PART 15 – RADIO FREQUENCY DEVICES ICES*-003, Issue 4 Interference-Causing Equipment Standard Digital Apparatus	FCC Part 15B Class A CA/CSA-CEI/IEC CISPR 22:10. This is CISPR 22:2008 with Canadian Modifications	USA Canada
IEC* 55024 Information Technology Equipment – Immunity characteristics – Limits and methods of measurement CISPR24:2010	EN-55024: 2010 and its amendments	European Union
IEC 55022 Information Technology Equipment – Radio disturbance Characteristics – Limits and methods of measurement CISPR24:2008 (Modified)	EN-55022: 2010 and its amendments	European Union
EN-60950-1 2 nd Edition	Information Technology Equipment – Safety – Part 1: General Requirements	USA/Canada
UL/CSA EN-60950-1 2 nd Edition	Information Technology Equipment – Safety – Part 1: General Requirements	USA/Canada



2.6 Reliability Specifications

Intel SSD DC P3700 Series meets or exceeds SSD endurance and data retention requirements as specified in the JESD218 standard. Reliability specifications are listed in the following table.

Table 15: Reliability Specifications

Parameter	Value
Uncorrectable Bit Error Rate (UBER) Uncorrectable bit error rate will not exceed one sector in the specified number of bits read. In the unlikely event of a non- recoverable read error, the SSD will report it as a read failure to the host; the sector in error is considered corrupt and is not returned to the host.	< 1 sector per 10 ¹⁷ bits read
Mean Time Between Failures (MTBF) Mean Time Between Failures is estimated based on Telcordia* methodology and demonstrated through Reliability Demonstration Test (RDT).	2 million hours
Data Retention The time period for retaining data in the NAND at maximum rated endurance.	3 months power-off retention once SSD reaches rated write endurance at 40° C
Endurance Rating The number of drive writes such that the SSD meets the requirements according to the JESD218 standard. Endurance rating verification is defined to establish UBER <1E-16 at 60% upper confidence limit.	400GB: 7.3 PBW 800GB: 14.6 PBW (10 drive writes/day*) 1.6TB: 43.8 PBW (15 drive writes/day*) 2.0TB: 62.05 PBW (17 drive writes/day*)

Note: Petabytes Written (PBW). Refer to JESD218 standard table 1 for UBER, FFR and other Enterprise SSD requirements.

2.7 Temperature Sensor

P3700 Series has an internal temperature sensor with an accuracy of +/-2° C over a range of -10° C to +85° C which can be monitored using NVMe Health Log.

For more information on sensor reading see SMART attributes section. In addition, drive will provide out of band access to temperature by means of SMBUS. The sensor has an accuracy of +/- 3° C over a range of -20° C to 125° C. SMBUS temperature sensor will not be reported in NVMe Health Log.

2.8 Power Loss Capacitor Test

P3700 Series supports testing of the power loss capacitor, which can be monitored using SMART attribute critical warning in log page identifier 02h, byte 0, bit 4.



2.9 Hot Plug Support

2.5-inch form factor will support surprise hot plug feature in capable platforms and OSs. P3700 Series supports hot insertion and removal and surprise hot insertion by means of presence detect and link-up detect. On surprise hot removal during IOs, P3700 Series will ensure the integrity of already committed data on the media and commit acknowledged writes to the media.

2.10 Out of Band Management (SMBUS)

Intel SSD DC P3700 Series provides out of band management by means of SMBUS interface. This requires 3.3V Auxiliary voltage. SMBUS accesses a VPD page as listed in Appendix B through address 0X53/0XA6 (7bit/8bit).

Temperature sensor is accessed through address 0x1B/0x36(7bit/8bit). For temperature sensor access, temperature can be read by the BMC (base) using Read Temperature Data Register (0x05) by means of SMBUS 0x1B. Bits [11:0] return raw ambient temperature.

Intel SSD DC P3700 provides additional drive information via address 0x6/0xD4(7bit/8bit) as outlined in the NVMe Basic Management Command (see <u>http://www.nvmexpress.org/wp-content/uploads/NVMe_Management_-</u> <u>Technical Note on Basic Management Command.pdf</u>).

Appendix B, C and D have details on the Out of Band Management data structure.

NOTES:

- 1. In certain tools the address for the VPD and temperature sensor will appear as 0xA6 and 0x36 respectively, due to bit shift.
- 2. BMC should not access the SMBUS address within 100msec of device power up, it may experience some glitch on the bus.

2.11 Variable Sector Size Support

P3700 Series supports 512, 520, 528, 4096, 4104, 4160 and 4224 byte sector sizes. P3700 Series will also support DIF as specified in NVMe 1.0 specification. Host sector sizes supporting DIF are 512 bytes and 4096 bytes with a PI (Protection Information) of 8 bytes.

In terms of protection information action (PRACT), bit 29 of DWORD12 in READ/WRITE command should not be equal to 1. Device only supports PRACT=0 implying protection information is passed to the SSD and checked by the SSD.



3 Mechanical Information

Figures 3-1 and 3-2 show the physical package information for the Intel SSD DC P3700 Series in the 2.5-inch form factors. All dimensions are in millimeters.

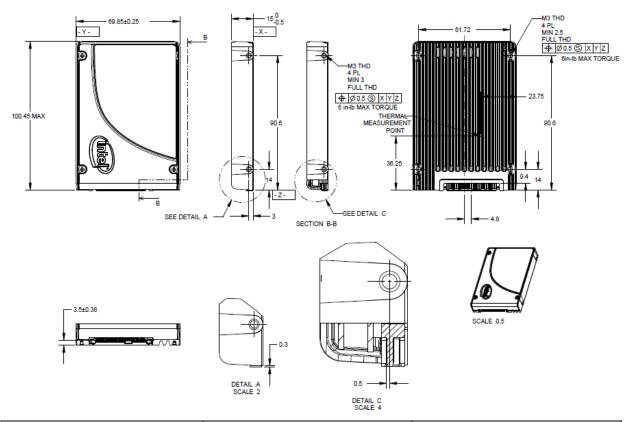


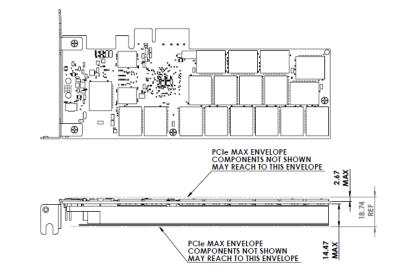
Figure 3-1: Intel SSD DC P3700 Series SFF Dimensions

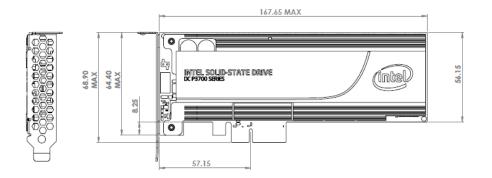
X – Length	Y - Width	Z - Height
100.45 Max	69.85 +/- 0.25	15.0 +0/-0.5

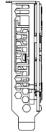
Note: Length does not include 0.3 connector protrusion



Figure 3-2: Intel SSD DC P3700 Series PCIe Dimensions







§



4 Pin and Signal Descriptions

4.2 Pin Signal Definitions

Table 16: Pin Definition for 2.5-inch Form Factor (8639 connector specification)

Pin	Name	Description	Pin	Name	Description
S1	GND	Ground	E7	REFCLK0+	Reference clock port 0
S2		Not used (SATA/SAS)	E8	REFCLK0-	Reference clock port 0
S3		Not used (SATA/SAS)	E9	GND	Ground
S4	GND	Ground	E10	PETp0	Transmitter differential pair, Lane 0
S5		Not used (SATA/SAS)	E11	PETn0	Transmitter differential pair, Lane 0
S6		Not used (SATA/SAS)	E12	GND	Ground
S7	GND	Ground	E13	PERn0	Receiver differential pair, Lane 0
E1	REFCLK1+	Reference clock port 1 (not used)	E14	PERp0	Receiver differential pair, Lane 0
E2	REFCLK1-	Reference clock port 1 (not used)	E15	GND	Ground
E3	3.3Vaux	3.3V auxiliary power	E16	RSVD	Reserved
E4	PERST1#	Fundamental reset port 1 (not used)	S8	GND	Ground
E5	PERST0#	Fundamental reset port 0	S9		Not used (SATAe/SAS)
E6	RSVD	Reserved	S10		Not used (SATAe/SAS)
P1		Not used (SATAe/SAS)	S11	GND	Ground
P2		Not used (SATAe/SAS)	S12		Not used (SATAe/SAS)
Р3		Not used (SATAe)	S13		Not used (SATAe/SAS)
P4	IfDet_N	Interface detect (drive type)	S14	GND	Ground
P5	GND	Ground	S15	RSVD	Reserved
P6	GND	Ground	S16	GND	Ground
P7		Not used (SATA/SAS)	S17	PETp1	Transmitter differential pair, Lane 1
P8		Not used (SATA/SAS)	S18	PETn1	Transmitter differential pair, Lane 1
P9		Not used (SATA/SAS)	S19	GND	Ground
P10	PRSNT_N	Presence detect (also used for drive type)	S20	PERn1	Receiver differential pair, Lane 1
P11	Activity	Activity signal from the drive	S21	PERp1	Receiver differential pair, Lane 1
P12	Hot-Plug	Ground	S22	GND	Ground
P13	+12V_pre	12V power	S23	PETp2	Transmitter differential pair, Lane 2
P14	+12V	12V power	S24	PETn2	Transmitter differential pair, Lane 2
P15	+12V	12V power	S25	GND	Ground
			S26	PERn2	Receiver differential pair, Lane 2
			S27	PERp2	Receiver differential pair, Lane 2
			S28	GND	Ground



Pin	Name	Description	Pin	Name	Description
			E17	РЕТр3	Transmitter differential pair, Lane 3
			E18	PETn3	Transmitter differential pair, Lane 3
			E19	GND	Ground
			E20	PERn3	Receiver differential pair, Lane 3
			E21	PERp3	Receiver differential pair, Lane 3
			E22	GND	Ground
			E23	SMCLK	SMBus clock
			E24	SMDAT	SMBus data
			E25	DualPortEn_N	Dual port enable

NOTES:

- SMCLK and SMDAT routes to an internal EEPROM which contains Vital Product Data (VPD).
- PRSNT_N is kept open by the P3700 Series.
- IfDet_N is grounded by P3700 Series.
- DualPortEn_N pin should be left un-connected or un-driven by the system to enable single port operation with all 4 lanes. If un-connected, P3700 Series will pull it high. However, if the pin is asserted by the system (driven low by storage backplane), then P3700 Series will be configured as x2 lanes
- Transmit differential pair lanes have 220 nF of AC coupling capacitance.
- P11 is used for activity. When idle, logic level is low (LED Solid On). During IO activity and formatting, pin toggles 250msec high, 250msec low signal.
- P3700 Series only uses REFCLK0+ and REFCLK0- as reference clock pair.
- P3700 Series only uses PERSTO# as a fundamental reset.
- 3.3Vaux is only needed during SMBUS access to the VPDROM.



		Side B	Side A	
Pin	Name	Description	Name	Description
1	+12V	12V power	PRSNT1#	Hot-Plug presence detect
2	+12V	12V power	+12V	12V power
3	+12V	12V power	+12V	12V power
4	GND	Ground	GND	Ground
5	SMCLK	SMBus(System Management Bus) clock	JTAG2	TCK (Test Clock), clock input for JTAG interface
6	SMDAT	SMBus (System Management Bus) data	JTAG3	TDI (Test Data Input)
7	GND	Ground / UART_HOST	JTAG4	TDO (Test Data Output)
8	+3.3V	3.3V power	JTAG5	TMS (Test Mode Select)
9	JTAG1	TRST# (Test Reset) resets the JTAG interface	+3.3V	3.3V power
10	3.3Vaux	3.3V auxiliary power	+3.3V	3.3V power
11	WAKE#	Signal for Link reactivation	PERST#	Fundamental reset
Mechar	nical Key			·
12	RSVD	Reserved	GND	Ground
13	GND	Ground	REFCLK+	Reference clock (differential pair)
14	PETp0	Transmitter differential pair, Lane 0	REFCLK-	Reference clock (differential pair)
15	PETn0	Transmitter differential pair, Lane 0	GND	Ground
16	GND	Ground	PERp0	Receiver differential pair, Lane 0
17	PRSNT2#	Hot-Plug presence detect	PERn0	Receiver differential pair, Lane 0
18	GND	Ground	GND	Ground
End of	the x1 Conne	ector		
19	PETp1	Transmitter differential pair, Lane 1	RSVD	Reserved
20	PETn1	Transmitter differential pair, Lane 1	GND	Ground
21	GND	Ground	PERp1	Receiver differential pair, Lane 1
22	GND	Ground	PERn1	Receiver differential pair, Lane 1
23	PETp2	Transmitter differential pair, Lane 2	GND	Ground
24	PETn2	Transmitter differential pair, Lane 2	GND	Ground
25	GND	Ground	PERp2	Receiver differential pair, Lane 2
26	GND	Ground	PERn2	Receiver differential pair, Lane 2
27	PETp3	Transmitter differential pair, Lane 3	GND	Ground
28	PETn3	Transmitter differential pair, Lane 3	GND	Ground
29	GND	Ground	PERp3	Receiver differential pair, Lane 3
30	RSVD	Reserved	PERn3	Receiver differential pair, Lane 3
50			1	1
31	PRSNT2#	Hot-Plug presence detect	GND	Ground

Table 17: Pin Definition for Add-In Card (Half Height Half Length) Form Factor

End of the x4 Connector

NOTES:

• All pins are numbered in ascending order from the left to the right, with side A on the top of the centerline and side B on the bottom of the centerline, use the reference drawing in Fig2, with the logo visible.

- The PCI Express interface pins PETpx, PETnx, PERpx, and PERnx are named with the following convention: "PE" stands for PCI Express high speed, "T" for Transmitter, "R" for Receiver, "p" for positive (+) and "n" for negative (-).
- The sequential mating for Hot-Plug is accomplished by staggering the edge fingers on the add-in card.

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5 Supported Command Sets

Intel SSD DC P3700 Series supports all mandatory Admin and I/O commands defined in NVMe (Non-Volatile Memory Express) revision 1.0.

5.1 NVMe Admin Command Set

P3700 Series supports all mandatory NVMe commands, which consists of:

- Delete I/O Submission Queue
- Delete I/O Completion Queue
- Create I/O Submission Queue
- Create I/O Completion Queue
- Get Log Page
- Identify
- Abort
- SET Features
- GET Features
- Asynchronous Event Notification

P3700 Series also supports the following optional I/O commands defined in NVMe revision 1.0:

- Firmware Activate
- Firmware Image Download
- Format NVM
- *Note:* See Appendix A, "Identify Controller Data Structure" for details on commands and capabilities.

5.2 NVMe I/O Command Set

P3700 Series supports all the mandatory NVMe I/O command set defined in NVMe 1.0 specification, which consists of:

- Flush
- Write
- Read

Additionally, the following optional commands are supported:

- Write Uncorrectable
- Dataset Management (De-allocate only)
- **Note:** See Appendix G, "SCSI Command Translation Table" for details on SCSI supported commands and capabilities.



5.3 Log Page Support

Intel SSD DC P3700 Series supports the following mandatory log pages defined in NVMe 1.0 specification:

- Error Information (Log Identifier 01h)
- SMART/ Health Information (Log Identifier 02h)
- Firmware Slot Information (Log Identifier 03h)
- Command Effects Log (Log Identifier 05h)
- *Note:* See NVMe 1.0 version of the specification for the log page content. Additionally, P3700 Series will support the following vendor unique log pages:
 - Log Page Directory (Log Identifier C0h)
 - Read Command Latency Statistics Log (Log Identifier C1h)
 - Write Command Latency Statistics Log (Log Identifier C2h)
 - Temperature Statistics (Log Identifier C5h)
 - Vendor Unique SMART Log (Log Identifier CAh)

5.4 SMART Attributes

The following table lists the SMART attributes supported by the P3700 Series in accordance with NVMe 1.0 specification.

Table 18: SMART Attributes (Log Identifier 02h)

Byte	# of Bytes	Attribute	Description
0	1	Critical Warning: These bits if set, flag various warning sources. Bit 0: Available Spare is below Threshold Bit 1: Temperature has exceeded Threshold Bit 2: Reliability is degraded due to excessive media or internal errors Bit 3: Media is placed in Read- Only Mode Bit 4: Volatile Memory Backup System has failed (e.g., enhanced power loss capacitor test failure) Bits 5-7: Reserved	Any of the critical warning can be tied to asynchronous event notification. Drive Health Indicator defined under bytes 3095- 3076 of Identify Controller may still indicate "healthy" status when the critical warning flag is set.
1	2	Temperature: Overall Device current temperature in Kelvin.	For AIC, this reports the NAND temperature, for 2.5-inch FF, this reports the case temperature,
3	1	Available Spare: Contains a normalized percentage (0 to 100%) of the remaining spare capacity available	Starts from 100 and decrements.
4	1	Available Spare Threshold	Threshold is set to 10%.
5	1	Percentage Used Estimate (Value allowed to exceed 100%)	A value of 100 indicates that the estimated endurance of the device has been consumed, but may not indicate a device failure. The value is allowed to exceed 100. Percentages greater than 254 shall be represented as 255. This value shall be updated once per power-on hour (when the controller is not in a sleep state).



Byte	# of Bytes	Attribute	Description
32	16	Data Units Read (in LBAs)	Contains the number of 512 byte data units the host has read from the controller; this value does not include metadata. This value is reported in thousands (i.e., a value of 1 corresponds to 1000 units of 512 bytes read) and is rounded up. When the LBA size is a value other than 512 bytes, the controller shall convert the amount of data read to 512 byte units.
48	16	Data Units Write (in LBAs)	Contains the number of 512 byte data units the host has written to the controller; this value does not include metadata. This value is reported in thousands (i.e., a value of 1 corresponds to 1000 units of 512 bytes written) and is rounded up. When the LBA size is a value other than 512 bytes, the controller shall convert the amount of data written to 512 byte units. For the NVM* command set, logical blocks written as part of Write operations shall be included in this value. Write Uncorrectable commands shall not impact this value.
64	16	Host Read Commands	Contains the number of read commands issued to the controller.
80	16	Host Write Commands	Contains the number of write commands issued to the controller.
96	16	Controller Busy Time (in minutes)	Contains the amount of time the controller is busy with I/O commands. The controller is busy when there is a command outstanding to an I/O Queue (specifically, a command was issued by way of an I/O Submission Queue Tail doorbell write and the corresponding completion queue entry has not been posted yet to the associated I/O Completion Queue). This value is reported in minutes.
112	16	Power Cycles	Contains the number of power cycles.
128	16	Power On Hours	Contains the number of power-on hours. This does not include time that the controller was powered and in a low power state condition.
144	16	Unsafe shutdowns	Contains the number of unsafe shutdowns. This count is incremented when a shutdown notification (CC.SHN) is not received prior to loss of power.
160	16	Media Errors	Contains the number of occurrences where the controller detected an unrecovered data integrity error. Errors such as uncorrectable ECC, CRC checksum failure, or LBA tag mismatch are included in this field.
176	16	Number of Error Information Log Entries	Contains the number of Error Information log entries over the life of the controller.



0 1 AB (Program Fail Count) Raw value: shows total count of program fails. Normalized value: beginning at 100, shows the percent remaining of allowable program fails. 3 1 Normalized Value Program fails. Normalized value: beginning at 100, shows the percent remaining of allowable program fails. Normalized value: beginning at 100, shows the percent remaining of allowable program fails. 15 1 Normalized Value Program fails. Normalized value: beginning at 100, shows the percent remaining of allowable program fails. 24 1 AD (Wear Leveling Count) Raw value: shows total count of erase fails. 27 1 Normalized Value Bytes 3-2: Max, erase cycle Bytes 3-2: Max, erase cycle Bytes 5-4: Ayg, erase cycles 29 6 Current Raw Value Raw value: reports number of End-Erno detected and corrected errons by hardware. Normalized value: always 100. 48 1 C7 (CRC Error Count) Raw value: measures the wear seen by the SSD 63 Raw value: measures the wear seen by the SSD 66 5 6 Current Raw Value Performance Counter Parameter for "Bad TLP". Normalized value: always 100. 6 Lurrent Raw Value Raw value: measures the wear seen by the SSD 63 Since reset of the workload immer, the specified in PCIe Link Percentage with 1 decin: heparcentage of I/O operations that are read operatio	Byte	# of Bytes	Attribute	Description
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15 1 Normalized Value Normalized value is always the percent remaining of allowable erase fails. 17 6 Current Raw Value Bytes 1-0: Min. erase cycle 27 1 Normalized Value Bytes 3-2: Max. erase cycle 29 6 Current Raw Value Bytes 5-4: May. erase cycle 36 1 B8 (End to End Error Detection Count) Raw value: always 100. 36 1 Normalized Value Normalized value: always 100. 41 6 Current Raw Value Normalized value: always 100. 48 1 C7 (CRC Error Count) Raw value: countered, as specified in PCIe Interface CRC errors encountered, as specified in PCIe Interface CRC errors encountered, as specified in PCIe Interface CRC errors and use: always 100. 50 1 E2 (Timed Workload, Media Wear) Raw value: measures the wear seen by the SSD (incre reset of the workload timer, attribute E4D) 65 6 Current Raw Value Normalized value: always 100. 72 1 E3 (Timed Workload, Host Reads %) Raw value: always 100. 73 6 Current Raw Value Normalized value: always 100. 74 1 E3 (Timed Workload, Host Reads %) Raw value: always 100. 75 1 Normalized Value Normalized Value: always 100. 77 6 Curr		6	Current Raw Value	percent remaining of allowable program fails.
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29 6 Current Raw Value Bytes 3-2: Max erase cycle 29 6 Current Raw Value Normalized value: decrements from 100 to 0. 36 1 B8 (End to End Error Detection Count) Raw value: reports number of End-to-End detected and corrected errors by hardware. 41 6 Current Raw Value Normalized value: decrements from 100 to 0. 48 1 C7 (CRC Error Count) Raw value: total number of PCIe Interface CRC errors encountered, as specified in PCIe Link 53 6 Current Raw Value Performance Counter Parameter for "Bad TLP". 53 6 Current Raw Value Normalized value: measures the wear seen by the SSD (since reset of the workload timer, attribute E4A) 60 1 E2 (Timed Workload, Media Wear) Raw value: shows the percentage of I/O operations that are read operations (since reset of the workload timer, attribute E4A) 65 6 Current Raw Value Normalized value: shows the percentage of I/O operations that are read operations (since reset of the workload timer, attribute E4A). Reported as integer percentage from 0 to 100. 77 6 Current Raw Value Normalized value: aways 100. 84 1 E4 (Timed Workload, Timer) Raw value: measures the elapsed time (number of file workload timer). 89 6 Current Raw Value Normalized value: aways 100. 101 6 <td< td=""><td>24</td><td>1</td><td>AD (Wear Leveling Count)</td><td>Raw value:</td></td<>	24	1	AD (Wear Leveling Count)	Raw value:
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113 6 Current Raw Value 120 1 F3 (PLL Lock Loss Count) Raw Value: Counter to indicate the number of times PCIe Refclock PLL has unlocked 123 1 Normalized Value Normalized Value is always 100	111	1	Normalized Value	
123 1 Normalized Value times PCIe Refclock PLL has unlocked Normalized Value Normalized Value is always 100	113	6	Current Raw Value	
123 1 Normalized Value Normalized Value is always 100	120	1	F3 (PLL Lock Loss Count)	
	123	1	Normalized Value	
	125	6	Current Raw Value	

Table 19: Additional SMART Attributes (Log Identifier CAh)



Byte	# of Bytes	Attribute	Description
132	1	F4 (NAND Bytes Written)	Nand sectors written divided by 65536 (1 count = 32 MiB)
135	1	Normalized Value	Normalized value always 100
137	6	Current Value	
144	1	F5 (Host Bytes Written)	Host sectors written divided by 65536 (1 count = 32 MiB)
147	6	Normalized Value	Normalized value always 100
149	6	Current Value	

5.5 Temperature Statistics

Table 20: Temperature Statistics (Log Identifier C5h)

Byte	# of Bytes	Description
0	8	Current Temperature
8	8	Overtemp shutdown Flag for last critical component temperature
16	8	Overtemp shutdown Flag for life critical component temperature
24	8	Highest temperature
32	8	Lowest temperature
80	8	Specified Maximum Operating Temperature
96	8	Specified Minimum Operating Temperature
104	8	Estimated offset

Note: For 2.5-inch form factor, case temperature is reported. For Add-in Card, NAND temperature is reported.



5.6 Drive Marketing Name Log

Table 21: Drive Marketing Name Log (Log Identifier DDh)

Byte	# of Bytes	Log Page Content
0	8	Intel
8	1	Space
9	3	SSD
12	1	Space
13	2	DC
15	1	Space
16	5	P3700
21	1	Space
22	6	Series
28-511	484	Reserved

5.7 IO Command Latency Statistics

Table 22: Read/Write Command Latency Log (Log Identifier C1h/C2h)

Byte	# of Bytes	Log Page Content
0	2	Major Revision
2	2	Minor Revision
4	128	First group of buckets: range 0-1ms, step 32us, each bucket size is 4 bytes, total 32 buckets
132	124	Second group of buckets: range 1-32ms, step 1ms, each bucket size is 4 bytes, total 31 buckets
256	124	Third group of buckets: range 32ms-1s, step 32ms, each bucket size is 4 bytes, total 31 buckets

5.8 SET Feature Identifiers

In addition to the SMART attribute structure, features pertaining to the operation and health of the Intel SSD DC P3700 Series can be reported to the host on request through the Get Features command. P3700 Series can change settings using SET Features on the following items as defined in NVMe 1.0 specification.

- Arbitration (Feature Identifier 01h)
- Power Management (Feature Identifier 02h)
- Temperature Threshold (Feature Identifier 04h)
- Error Recovery (Feature Identifier 05h)
- Volatile Write Cache (Feature Identifier 06h)
- Number of Queues (Feature Identifier 07h)
- Interrupt Coalescing (Feature Identifier 08h)
- Interrupt Vector Configuration (Feature Identifier 09h)
- Write Atomicity (Feature Identifier 0Ah)
- Asynchronous Event Configuration (Feature Identifier 0Bh)

Product Specification 28



Intel[®] Solid-State Drive DC P3700 Series

Intel SSD DC P3700 Series will also support the following vendor unique SET Features.

- Set/Get Max LBA (Feature Identifier C1h)
- Get Native Max LBA (Feature Identifier C2h)
- Power Governor Setting (Feature Identifier C6h)
- Reset Timed Workload Counters (Feature Identifier D5h)
- Set/Get Enable Latency Tracking (Feature Identifier E2h)

Table 23: Set Max LBA Setting - Command Dword 11 and Command Dword 12

Bit	Description
63:00	Maximum User LBA: Write Usage: This field sets the 64-bit maximum LBA addressable by the Drive. Read Usage: This field contains the 64-bit maximum LBA addressable by the Drive. Command Dword 11 contains bits 31:00; Command Dword 12 contains bits 63: 32.

Table 24: Status Code - Set Max LBA Command Specific Status Values

Value	Description
C0h	Requested MAX LBA exceeds Available capacity
C1h	Requested MAX LBA smaller than minimum allowable limit.
C2h	Requested MAX LBA is smaller than allocated Namespace requirements

Table 25: C6h - Set/ Get Power (Typical) Governor Setting - Command Dword 11

Bit	Description
31:08	Reserved (TBD)
07:00	Power Governor Setting: 00h = 25W , 01h = 20W , 02h = 10W

Table 26: Status Codes - Power Governor Setting Command Specific Status Values

Value	Description
C0h	Invalid Setting

Table 27: D5h – Reset Timed Workload Counters – Command Dword 11

Bit	Description
31:01	Reserved
00	Timed Workload Reset Settings: Write Usage: 00 = NOP, 1 = Reset E2, E3,E4 counters; Read Usage: Not Supported

Note: Get Features will not work for "Reset Timed Workload Counters" and status code is same as Table 25.

Table 28: E2h – Set/Get Enable Latency Tracking

Bit	Description
31:01	Write Usage: 00h = Disable Latency Tracking (Default) 01h = Enable Latency Tracking



6 NVMe Driver Support

The following table describes the NVMe Driver Support for Intel SSD DC P3700 Series. The support includes releasing and validating NVMe drivers for certain operating systems and validating functionality for open source drive, inbox or native drivers for select operating systems.

Table 29: NVMe Driver Support

Support Level	Operating System Description	
Intel Provided ¹	Windows Server 2012 R2, 2012, 2008 R2 x64, Windows 7(32bit/64bit), Windows 8 (32bit/64bit), Windows 8.1, Windows 10, (32bit/64Bit), VMWare ESXi 5.5	
In-box Driver ²	RHEL 6.5, RHEL 6.6, RHEL 6.7, RHEL 7.0, RHEL 7.1, SLES11 SP3, SP4, SLES12, CentOS 6.5, Citrix XenServer 6.5, Windows Server 2012 R2, Windows 8.1	

NOTES:

1. With Intel provided driver, full product specification is guaranteed, booting is only supported for 64bit OS

2. With open source non-Intel driver, compatibility and functionality is validated



7 Certifications and Declarations

Table 30: Device Certifications and Declarations

Certification	Description			
CE* Compliant	European Economic Area (EEA): Compliance with the essential requirements of EC Council Directives Low Voltage Directive (LVD) 2006/95/EC, EMC Directive 2004/108/EC and Directive 2011/65/EU.			
UL* Recognized	Certified Underwriters Laboratories, Inc. Bi-National Component Recognition; UL 60950-1, 2nd Edition, 2007-03-27 (Information Technology Equipment - Safety - Part 1: General Requirements) CSA C22.2 No. 60950-1-07, 2nd Edition, 2007-03 (Information Technology Equipment - Safety - Part 1: General Requirements)			
C-Tick* Compliant	Compliance with the Australia/New Zealand Standard AS/NZS3548 and Electromagnetic Compatibility (EMC) Framework requirements of the Australian Communication Authority (ACA).			
BSMI* Compliant	Compliance to the Taiwan EMC standard CNS 13438: Information technology equipment - Radio disturbance Characteristics - limits and methods of measurement, as amended on Jun 2006, is harmonized with CISPR 22: 2005.04.			
KCC*	Compliance with paragraph 1 of Article 11 of the Electromagnetic Compatibility Control Regulation and meets the Electromagnetic Compatibility (EMC) Framework requirements of the Radio Research Laboratory (RRL) Ministry of Information and Communication Republic of Kore			
VCCI*	Voluntary Control Council for Interface to cope with disturbance problems caused by personal computers or facsimile.			
Microsoft* WHCK	Microsoft Windows Hardware Certification Kit			
RoHS* Compliant	Restriction of Hazardous Substance Directive			
WEEE*	Directive on Waste Electrical and Electronic Equipment			



Appendix A IDENTIFY Data Structure

Bytes	F = Fixed V = Variable X = Both	Default Value	Interpretation	Description
1-0	F	8086h	Contains the company vendor identifier that is assigned by the PCI SIG	PCI Vendor ID (VID)
3-2	F	8086h	Contains the company vendor identifier that is assigned by the PCI SIG for subsystem	PCI Subsystem Vendor ID (SSVID)
23-4	V	varies	Contains the serial number for the NVM subsystem	Serial Number (SN)
63-24	V	varies	Contains the serial number for the NVM subsystem that is assigned by the vendor as an ASCII string	Model Number (MN)
71-64	V	varies	Contains the currently active firmware revision for the NVM subsystem	Firmware Revision (FR)
72	F	0h	Recommended Arbitration Burst size equals 1	Recommended Arbitration Burst (RAB)
75-73	F	5CD2E4h	Contains the Organization Unique Identifier (OUI) for the controller vendor	IEEE OUI Identifier (IEEE)
76	х	Oh	No of multiple PCI Express interfaces connected to the host, bit 0 determines multiple interface	Multi-Interface Capabilities (MIC)
77	F	05h	Supports MDTS of 128K	Maximum Data Transfer Size (MDTS)
255:78				Reserved
257-256	F	06h	Supports Security Send/Receive, Format NVM and Firmware Activate/Download	Optional Admin Command Support (OACS)
258	F	03h	Supports up to 3 concurrently outstanding abort commands	Abort Command Limit (ACL)
259	F	03h	Supports up to 3 concurrently outstanding asynchronous event requests	Asynchronous Event Request Limit (AERL)
260	х	02h	Single slot Read/write capable	Firmware Updates (FRMW)
261	х	Oh	SMART/Health Log Support per drive not per namespace	Log Page Attributes (LPA)
262	F	3Fh	Number of Error Information log entries equals 64 Error Log Page Entries (ELPE)	
263	F	Oh	Number of NVM Express power states equal 1	Number of Power States Support (NPSS)
264	F	0h	Configuration settings for Admin Admin Vendor Specific Commar Vendor Specific command handling Configuration (AVSCC)	

Table 31: Identify Controller

Product Specification



Bytes	F = Fixed V = Variable X = Both	Default Value	Interpretation	Description	
511-265				Reserved	
512	F	66h	Required and max submission queue entry size is 64 Byte Submission Queue Entry Size		
513	F	44h	Required and max submission queue entry size is 16 Byte	Completion Queue Entry Size (CQES)	
515-514				Reserved	
519-516	F	01h	Supports single namespace	Number of Namespaces (NN)	
521-520	F	06h	Supports Dataset Management and Write Uncorrectable optional NVMe commands.	Optional NVMe Command Support (ONCS)	
523-522	F	0h	Fused commands not supported	Fused Operation Support (FUSES)	
524	F	07h	Supports Crypto Erase and format of entire drive, not per namespace	Format NVM Attributes (FNA):	
525	F	0h	Volatile write cache is not present	Volatile Write Cache (VWC)	
527-526	F	Oh	Atomic write size for controller during normal equals to 512B	Atomic Write Unit Normal (AWUN)	
529-528	F	Oh	Indicates the atomic write size for the controller during a power fail condition equals 512B	Atomic Write Unit Power Fail (AWUPF)	
530	х	0h	Not Supported	NVM Vendor Specific Command Configuration (NVSCC)	
703-531				Reserved	
2047-704				Reserved	
2079-2048	V		Indicates the characteristics of power state 0	Power State 0 Descriptor (PSD0)	
2111-2080	V		Indicates the characteristics of power state 1	Power State 1 Descriptor (PSD1)	
2143-2112	V		Indicates the characteristics of power state 2	Power State 2 Descriptor (PSD2)	
2175-2144	V		Indicates the characteristics of power state 3	Power State 3 Descriptor (PSD3)	
2207-2176	V		Indicates the characteristics of power state 4	Power State 4 Descriptor (PSD4)	
2239-2208	V		Indicates the characteristics of power state 5	Power State 5 Descriptor (PSD5)	
2271-2240	v		Indicates the characteristics of power state 6	Power State 6 Descriptor (PSD6)	
2303-2272	V		Indicates the characteristics of power state 7	Power State 7 Descriptor (PSD7)	
2335-2304	V		Indicates the characteristics of power state 8	of Power State 8 Descriptor (PSD8)	
2367-2336	v		Indicates the characteristics of power state 9	Power State 9 Descriptor (PSD9)	
2399-2368	V		Indicates the characteristics of power state 10	Power State 10 Descriptor (PSD10)	
2431-2400	V		Indicates the characteristics of power state 11	Power State 11 Descriptor (PSD11)	

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Bytes	F = Fixed V = Variable X = Both	Default Value	Interpretation	Description	
2463-2432	V		Indicates the characteristics of power state 12	Power State 12 Descriptor (PSD12)	
2495-2464	V		Indicates the characteristics of power state 13	Power State 13 Descriptor (PSD13)	
2527-2496	V		Indicates the characteristics of power state 14	Power State 14 Descriptor (PSD14)	
2559-2528	V		Indicates the characteristics of power state 15	Power State 15 Descriptor (PSD15)	
2591-2560	V		Indicates the characteristics of power state 16	Power State 16 Descriptor (PSD16)	
2623-2592	V		Indicates the characteristics of power state 17	Power State 17 Descriptor (PSD17)	
2655-2624	V		Indicates the characteristics of power state 18	Power State 18 Descriptor (PSD18)	
2687-2656	V		Indicates the characteristics of power state 19	Power State 19 Descriptor (PSD19)	
2719-2688	V		Indicates the characteristics of power state 20	Power State 20 Descriptor (PSD20)	
2751-2720	V		Indicates the characteristics of power state 21	Power State 21 Descriptor (PSD21)	
2783-2752	V		Indicates the characteristics of power state 22	Power State 22 Descriptor (PSD22)	
2815-2784	V		Indicates the characteristics of power state 23	Power State 23 Descriptor (PSD23)	
2847-2816	V		Indicates the characteristics of power state 24	Power State 24 Descriptor (PSD24)	
2879-2848	V		Indicates the characteristics of power state 25	Power State 25 Descriptor (PSD25)	
2911-2880	V		Indicates the characteristics of power state 26	Power State 26 Descriptor (PSD26)	
2943-2912	V		Indicates the characteristics of power state 27	Power State 27 Descriptor (PSD27)	
2975-2944	V		Indicates the characteristics of power state 28	Power State 28 Descriptor (PSD28)	
3007-2976	V		Indicates the characteristics of power state 29	Power State 29 Descriptor (PSD29)	
3039-3008	V		Indicates the characteristics of power state 30	Power State 30 Descriptor (PSD30)	
3071-3040	V		Indicates the characteristics of power state 31	Power State 31 Descriptor (PSD31)	
3075	F	05h	Data striped at 128 KB, value shown is reported as 2^ (CAP.MPSMIN)	Internal stripe size	
3095-3076	V	Varies	Shows healthy status or error code	Health indicator	
3096	V	Varies	Reads current negotiated PCIe link speed, as reported by PXLS register (PXCAP + 12h), bits[3:0]	Current PCIe Link Speed field (CLS)	



Bytes	F = Fixed V = Variable X = Both	Default Value	Interpretation	Description	
3097	V	Varies	Reads current negotiated PCIe Link Width as reported by PXLS register (PXCAP + 12h), bits[9:4] Negotiated Link Width (NLW)		
3107-3100	V	Varies	Bootloader Version	Bootloader Version reported by the drive	
3109-3108	F	0x8086	Company Vendor Identifier	Vendor identifier assigned by PCI-SIG (Intel)	
3111-3110	F	0x0953	Device Identifier	Device identifier assigned by PCI-SIG (Intel)	
4095-3112	V	NA	Range of bytes is allocated for vendor specific usage	Vendor Specific (VS)	

NOTES:

F = Fixed. The content of the word is fixed and does not change. For removable media devices, these values may change when media is removed or changed.

V = **Variable**. The state of at least one bit in a word is variable and may change depending on the state of the device or the commands executed by the device.

X = F or V. The content of the word may be fixed or variable.



Table 32: Power State Descriptor

Bytes	F = Fixed V = Variable X = Both	Default Value	Interpretation	Description	
255-125				Reserved	
124-120	F	Oh	Indicates the relative write latency associated with this power state	Relative Write Latency (RWL)	
119-117				Reserved	
116-112	F	Oh	Indicates the relative write throughput associated with this power state	Relative Write Throughput (RWT)	
111-109				Reserved	
108-104	F	Oh	Indicates the relative read latency associated with this power state	Relative Read Latency (RRL)	
103-101				Reserved	
100-96	F	Oh	Indicates the relative read throughput associated with this power state.	Relative Read Throughput (RRT)	
95-64	F	Oh	Indicates the maximum exit latency in microseconds associated with exiting this power state.	Exit Latency (EXLAT)	
63-32	F	Oh	Indicates the maximum entry latency in microseconds associated with entering this power state	Entry Latency (ENLAT)	
31-16				Reserved	
15-00	F	09C4h	Indicates the maximum power consumed by the NVM subsystem in this power state. The power in Watts is equal to the value in this field multiplied by 0.01	Maximum Power (MP)	

NOTES:

F = Fixed. The content of the word is fixed and does not change. For removable media devices, these values may change when media is removed or changed.

V = Variable. The state of at least one bit in a word is variable and may change depending on the state of the device or the commands executed by the device.

X = **F** or **V**. The content of the word may be fixed or variable.



Table 33: Identify Namespace

Bytes	F = Fixed V = Variable X = Both	Default Value	Interpretation	Description	
7-0	V	varies	Indicates the total size of the namespace in logical blocks.	Namespace Size (NSZE)	
15-8	v	varies	Indicates the maximum number of logical blocks that may be allocated in the namespace at any point in time	Namespace Capacity (NCAP)	
23-16	v	varies	Indicates the current number of logical blocks allocated in the namespace	Namespace Utilization (NUSE)	
24	F	00h	Indicates thin provisioning is not supported	Namespace Features (NSFEAT)	
25	F	06h	Defines the number of supported LBA size and metadata size combinations supported by the namespace	Number of LBA Formats (NLBAF)	
26	V	00h	Indicates metadata transferred with the extended data LBA or in separate buffer	Formatted LBA Size (FLBAS)	
27	F	03h	Indicates support for metadata transferred with the extended data LBA and in separate buffer – both are supported	Metadata Capabilities (MC)	
28	V	11h	Indicates PI supports Type 1,2,3 with PI transferred as the first 8 bytes	End-to-end Data Protection Capabilities (DPC)	
29	х	00h	Indicates type settings for the namespace	End-to-end Data Protection Type Settings (DPS)	
127-30				Reserved	
131-128	v	MS:0, LBADS:9, RP:2	Indicates the LBA format 0 that is supported by the controller	LBA Format O Support (LBAFO)	
135-132	V	MS:8, LBADS:9, RP:2	Indicates the LBA format 1 that is supported by the controller	LBA Format 1 Support (LBAF1)	
139-136	V	MS:16, LBADS:9, RP:2	Indicates the LBA format 2 that is supported by the controller	LBA Format 2 Support (LBAF2)	
143-140	V	MS:0, LBADS:12, RP:0	Indicates the LBA format 3 that is supported by the controller	LBA Format 3 Support (LBAF3)	
147-144	V	MS:8, LBADS:12, RP:0	Indicates the LBA format 4 that is supported by the controller	LBA Format 4 Support (LBAF4)	
151-148	V	MS:64, LBADS:12, RP:0	Indicates the LBA format 5 that is supported by the controller	LBA Format 5 Support (LBAF5)	

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Bytes	F = Fixed V = Variable X = Both	Default Value	Interpretation	Description	
155-152	V	MS:128, LBADS:12, RP:0	Indicates the LBA format 6 that is supported by the controller	LBA Format 6 Support (LBAF6)	
159-156		Not supported	Indicates the LBA format 7 that is supported by the controller	LBA Format 7 Support (LBAF7)	
163-160		Not supported	Indicates the LBA format 8 that is supported by the controller	LBA Format 8 Support (LBAF8)	
167-164		Not supported	Indicates the LBA format 9 that is supported by the controller	LBA Format 9 Support (LBAF9)	
171-168		Not supported	Indicates the LBA format 10 that is supported by the controller	LBA Format 10 Support (LBAF10)	
175-172		Not supported	Indicates the LBA format 11 that is supported by the controller	LBA Format 11 Support (LBAF11)	
179-176		Not supported	Indicates the LBA format 12 that is supported by the controller	LBA Format 12 Support (LBAF12)	
183-180		Not supported	Indicates the LBA format 13 that is supported by the controller	LBA Format 13 Support (LBAF13)	
187-184		Not supported	Indicates the LBA format 14 that is supported by the controller	LBA Format 14 Support (LBAF14)	
191-188		Not supported	Indicates the LBA format 15 that is supported by the controller	LBA Format 15 Support (LBAF15)	
383-192		Not supported		Reserved	
4095-384		Not supported	Range of bytes is allocated for vendor specific usage	Vendor Specific (VS)	

NOTES:

F = Fixed. The content of the word is fixed and does not change. For removable media devices, these values may change when media is removed or changed.

V = Variable. The state of at least one bit in a word is variable and may change depending on the state of the device or the commands executed by the device.

X = F or V. The content of the word may be fixed or variable



Table 34: LBA Format Data Structure

Bytes	F = Fixed V = Variable X = Both	Default Value	Interpretation	Description
31-26				Reserved
25-24	V	Varies (2,0)	Relative Performance ranging from "best" to "degraded"	Relative Performance (RP)
23-16	V	Varies (9 and 12)	Indicates the LBA data size supported. The value is reported in terms of a power of two (2^n)	LBA Data Size (LBADS)
15-00	V	Varies (0, 8, 16,64, 128)	Indicates the number of metadata bytes provided per LBA based on the LBA Data Size indicated.	Metadata Size (MS)

NOTES:

F = Fixed. The content of the word is fixed and does not change. For removable media devices, these values may change when media is removed or changed.

V = Variable. The state of at least one bit in a word is variable and may change depending on the state of the device or the commands executed by the device.

X = F or V. The content of the word may be fixed or variable.



Appendix B Vital Data Structure

Address	# Bytes	Function	Programming Value	Byte	Description
			02h	0	
0	3	Class Code	08h	1	Device type and Programming Interface
			01h	2	
з	2		86h	3	PCI-SIG Vendor ID
5	2		80h	4	
5	20	ID	Varies	5-24	Serial Number
25	40		Varies	25-64	Model Number
65	1	PCle Port0	03h	65	Maximum Link Speed
66	1	Capabilities	04h	66	Maximum Link Width
67	1	PCle Port1	03h	67	Maximum Link Speed
68	1	Capabilities	04h	68	Maximum Link Width
69	1	Initial Power Requirements	0Ah	69	12V Power rail initial power requirement (W)
70	2	Reserved	00h	70-71	
72	1	Maximum Power Requirements	19h	72	12V Power rail maximum power requirement (W)
73	2	Reserved	00h	73-74	
75	2	Capability List Pointer	50h	75	16b address pointer to start of capability list

Table 35: Vital Product Data Structure (VPD)

Table 36: Capability List Pointer (Out of Band Temperature Sensor)

Addr (Hex)	00	01	02	03	04	05	06	07	08	09	Α	В
50	A2	00	00	00	00	36	00	00	varies	varies	varies	varies
Description	Capabili (temp)	ty ID	Next Car (none)	oability	Sensor Type	SMBUS address	Reserve	d	Warning Thresho		Over Tempera	ature



Appendix C Out of Band Temperature Sensor Read Out

Register 0x05 on address 0x1B contains the temperature information for the latest readout. Measured temperature is captured by bit 12 to bit 0. Data format is two's complement. Bit12 represents sign value, bit11 presents 128° C and bit0 represents 0.0625° C. Following table gives an example of the read out.

Table 37:	Register	0x05	read	out	format
-----------	----------	------	------	-----	--------

Binary	Нех	Temperature
1 1100 1001 0000	1C90	-55° C
1 1100 1110 0000	1CE0	-50° C
1 1110 0111 0000	1E70	-25° C
1 1111 1111 1111	1FFFF	-0.0625° C
0 0000 0000 0000	000	0° C
0 0000 0000 0001	001	0.0625° C
0 0001 1001 0000	190	25° C
0 0011 0010 0000	320	50° C
0 0111 1101 0000	7D0	55° C



Appendix D SMBUS Command Response on 0x6A (NVMe Workgroup Defined)

Table 38: Command Response on 0x6A (NVMe Workgroup Defined)

Command Code	Offset (byte)	Description
	00	Length of Status: Indicates number of additional bytes to read before encountering PEC. This value should always be 6 (06h) in implementations of this version of the spec.
0	01	Status Flags (SFLGS): This field indicates the status of the NVM subsystem. SMBus Arbitration – Bit 7 is set '1' after a SMBus block read is completed all the way to the stop bit without bus contention and cleared to '0' if a SMBus Send Byte FFh is received on this SMBus slave address. Drive Not Ready – Bit 6 is set to '1' when the subsystem cannot process NVMe management commands, and the rest of the transmission may be invalid. If cleared to '0', then the NVM subsystem is fully powered and ready to respond to management commands. This logic level intentionally identifies and prioritizes powered up and ready drives over their powered off neighbors on the same SMBus segment. Drive Functional – Bit 5 is set to '1' to indicate an NVM subsystem is functional. If cleared to '0', then there is an unrecoverable failure in the NVM subsystem and the rest of the transmission may be invalid. Reset Not Required - Bit 4 is set to '1' to indicate the NVM subsystem does not need a reset to resume normal operation. If cleared to '0' then the rest or that prevents continued normal operation. A controller reset is required to resume normal operation. Port 0 PCle Link Active - Bit 3 is set to '1' to indicate the first port's PCle link is up (i.e., the Data Link Control and Management State Machine is in the DL_Active state). If cleared to '0', then the PCle link is down. Port 1 PCle Link Active - Bit 2 is set to '1' to indicate the second port's PCle link is up. If cleared to '0', then the second port's PCle link is down or not present.
	02	Bits 1-0 shall be set to '1'. SMART Warnings: This field shall contain the Critical Warning field (byte 0) of the NVMe SMART / Health Information log. Each bit in this field shall be inverted from the NVMe definition (i.e., the management interface shall indicate a '0' value while the corresponding bit is '1' in the log page). Refer to the NVMe specification for bit definitions. If there are multiple controllers in the NVM subsystem, the management endpoint shall combine the Critical Warning field from every controller such that a bit in this field is: Cleared to '0' if any controller in the subsystem indicates a critical warning for that corresponding bit. Set to '1' if all controllers in the NVM subsystem do not indicate a critical warning for the corresponding bit.
	03	Composite Temperature (CTemp): This field indicates the current temperature in degrees Celsius. If a temperature value is reported, it should be the same temperature as the Composite Temperature from the SMART log of hottest controller in the NVM subsystem. The reported temperature range is vendor specific, and shall not exceed the



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Command Code	Offset (byte)	Description					
		_	+127°C. The 8 bit format of the data is shown below.				
			ould not report a temperature when that is older than 5 seconds. If recent vailable, the NVMe management endpoint should indicate a value of 80h fo				
		Value	Description				
		00h-7Eh	Temperature is measured in degrees Celsius (0° to 126°C)				
		7Fh	127° C or higher				
		80h	No temperature data or temperature data is more than 5 seconds old.				
		81h	Temperature sensor failure				
		82h-C3h	Reserved				
		C4	Temperature is -60° C or lower				
		C5-FFh	Temperature measured in degrees Celsius is represented in twos complement (-1° to -59° C)				
	04	Percentage Drive Life Used (PDLU): Contains a vendor specific estimate of the percentage of NVM subsystem NVM life used based on the actual usage and the manufacturer's prediction of NVM life. If an NVM subsystem has multiple controllers the highest value is returned. A value of 100 indicates that the estimated endurance of the NVM in the NVM subsystem has been consumed, but may not indicate an NVM subsystem failure. The value is allowed to exceed 100. Percentages greater than 254 shall be represented as 255. This value should be updated once per power-on hour and equal the Percentage Used value in the NVMe SMART Health Log Page.					
	06:05	Reserved: Shall be set to 0000h					
	07	PEC: An 8 bit CRC calculated over the slave address, command code, second slave address and returned data. Algorithm is in SMBus Specifications.					
	08	Length of identification: Indicates number of additional bytes to read before encountering PEC. This value should always be 22 (16h) in implementations of this version of the spec.					
8	10:09	Vendor ID: The 2 byte vendor ID, assigned by the PCI SIG. Should match VID in the Identify Controller command response. MSB is transmitted first.					
	30:11	Serial Number: 20 characters that match the serial number in the NVMe Identify Controller command response. First character is transmitted first					
	31	PEC: An 8 bit CRC calculated over the slave address, command code, second slave address and returned data. Algorithm is in SMBus Specifications.					
32+	255:32	Vendor Specific – This data structure shall not exceed the maximum read length of 255 specified in the SMBus version 3 specification. Preferably length is not greater than 32 for compatibility with SMBus 2.0, additional blocks shall be on 8 byte boundaries.					



Appendix E SMBUS Command Response on 0x6A (Intel Specific)

Table 39: Command Response on 0x6A (Intel Specific)

Command Code	Offset (byte)	Description				
	32	Length of Intel Corporation's Block: shall be 22 until this spec is updated				
	33	Reserved: Currently cleared to zero. Anticipated future use will be several bits for version number, a bit if there are additional Intel blocks, and some other less thought out ideas at this point				
	34	Reserved: Value = 0xff				
32	35	Reserved: Value = 0x80				
	38:36	Reserved: Value = 0x000000				
	46:39	Firmware Version: 8 characters, ASCII representation				
	54:47	Bootloader Version: 8 characters, ASCII representation				
	55	PEC: An 8 bit CRC calculated over the slave address, command code, second slave address and returned data. Algorithm is in SMBus Specifications.				
56+	255:56	Reserved: all bytes cleared to zero, no PEC				



Appendix F PCIe* ID

Table 40: PCIe ID

ID name	Description	Add-in Card	2.5" FF	PCIe Register Location	Identify Controller Location	Vital Product Data Location
Vendor ID (VID)	Vendor ID assigned by PCI-SIG	0x8086	0x8086	PCI Header Offset 00h (bits 15:00)	Bytes 01:00h	Address 3, (size 2B)
Device ID (DID)	Device ID assigned by vendor	0x0953	0x0953	PCI Header Offset 00h (bits 31:16)	NA	NA
Subsystem Vendor ID	Indicates Sub- system vendor ID	0x8086	0x8086	PCI Header Offset 2Ch (bits 15:00)	Bytes 03:02h	NA
Subsystem ID	Sub-system identifier	0x3702	0x3703	PCI Header Offset 2Ch (bits 31:16)	NA	NA



Appendix G SCSI Command Translation

Following SCSI commands are supported:

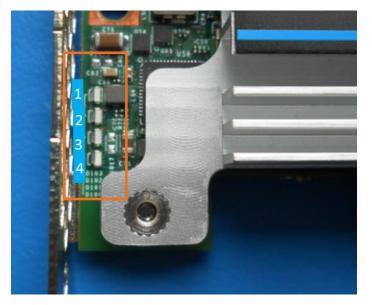
- Read 6,10,12,16
- Inquiry
- Mode Sense 6,10
- Mode Select 6.10
- Log Sense
- Read Capacity 10,16
- Report LUNs
- Request Sense
- Start Stop Unit
- Test Unit Ready
- Write Buffer
- Unmap
- Note: Refer to NVM Express*: SCSI translation reference doc under <u>nvmexpress.org</u>.

Appendix H Add-in Card LED Decoder

Table 41: LED Functionality

LED	Description	Blink Behavior
LED 1 (Amber)	Shows IO activity	Blinks at the rate of 250msec high, 250msec low with IO activity
LED 2 (Red)	Drive fail indicator	Solid red if drive is in disabled logical mode
LED 3 (Yellow)	Drive pre-fail indicator	Solid yellow if any of the critical warnings in log page 0x02 is triggered
LED 4 (Green)	Drive health indicator	Solid green when drive is healthy

Figure A-1: LED Location



Note: 2.5-inch Form factor does not contain LEDs